CERAMIC

Power Splitter/Combiner SCG-2-592+

2 Way-0° 50Ω 3800 to 5900 MHz

FEATURES

- Isolation resistor, external 100 ohms
- Low insertion loss, 0.8 dB typ.
- Excellent amplitude unbalance, 0.1 dB typ.
- Excellent phase unbalance, 1.5 deg. typ.
- High isolation, 15 dB typ.
- ESD non-sensitive
- Temperature stable LTCC technology
- Wrap around terminations for excellent solderability
- Low cost

Generic photo used for illustration purposes only

CASE STYLE: GE0805C-1

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- ISM
- WLAN

ELECTRICAL SPECIFICATIONS AT 25°C

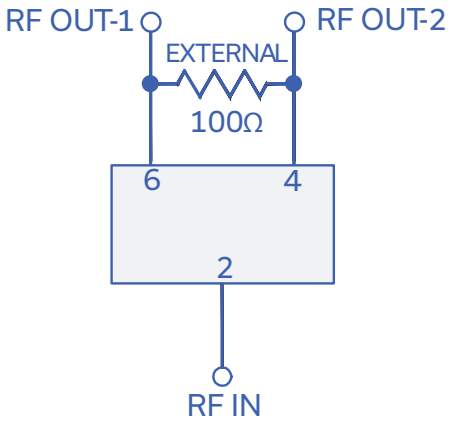
Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		3800		5900	MHz
Insertion Loss, above 3.0 dB	3800 - 5900	—	0.8	1.4	dB
Isolation	3800 - 5900	11	15	—	dB
Phase Unbalance	3800 - 5900	—	1.5	7.0	Degree
Amplitude Unbalance	3800 - 5900	—	0.1	0.5	dB
Return Loss (Input)	3800 - 5900	—	16	—	dB
Return Loss (Output)	3800 - 5900	—	20	—	dB

MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
Power Input (as a splitter)	2W* max.

* Derate linearly to 0.7W at 100°C ambient, power input as combiner is limited by rating of external resistor 100Ω resistor.
Permanent damage may occur if any of these limits are exceeded.

ELECTRICAL SCHEMATIC



REV. A
ECO-009562
SCG-2-592+
SL/CP/AM
220928

CERAMIC

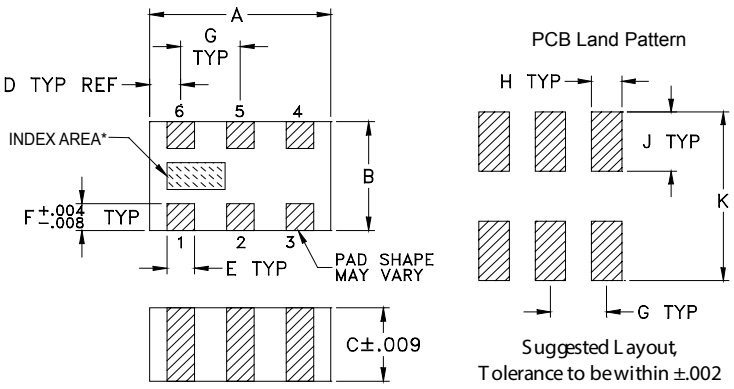
Power Splitter/Combiner SCG-2-592+

2 Way-0° 50Ω 3800 to 5900 MHz

PAD CONNECTIONS

SUM PORT	2
PORT 1	6
PORT 2	4
GROUND	1,3,5
PORT 1-2	resistor external 100 ohms

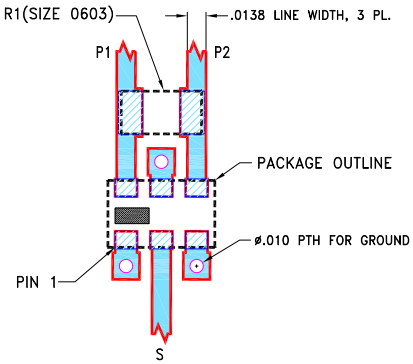
OUTLINE DRAWING



*Shape of index marking may vary

PRODUCT MARKING: SL

DEMO BOARD MCL P/N: TB-1043+
SUGGESTED PCB LAYOUT (PL-560)



NOTES:
1. LINE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS LINE WIDTH MAY NEED TO BE MODIFIED.
2. UNIT FOOT PRINT IS OPTIMIZED FOR PERFORMANCE AND IS DIFFERENT FROM CASE STYLE GE0805C-1 RECOMMENDATIONS.
3. CHIP COMPONENT FOOT PRINT IS SHOWN FOR REFERENCE. FOR COMPONENT VALUE REFER TO TB-1043+.
4. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F
.079	.049	.033	.014	.012	.012
2.01	1.24	0.84	0.36	0.30	0.30

G	H	J	K		wt
.026	.014	.039	.110		grams
0.66	0.36	1.00	2.80		.008

TAPE & REEL INFORMATION: F74

CERAMIC

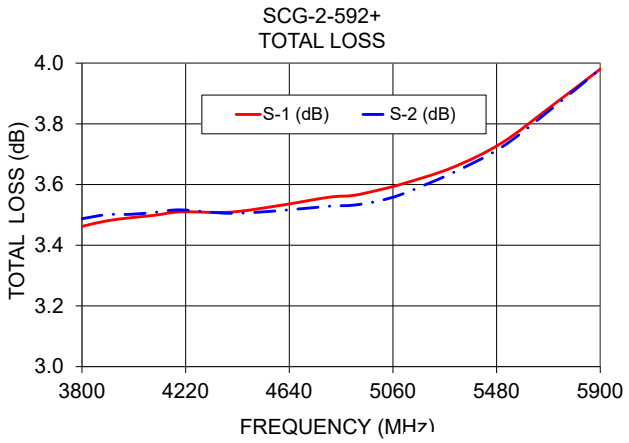
Power Splitter/Combiner SCG-2-592+

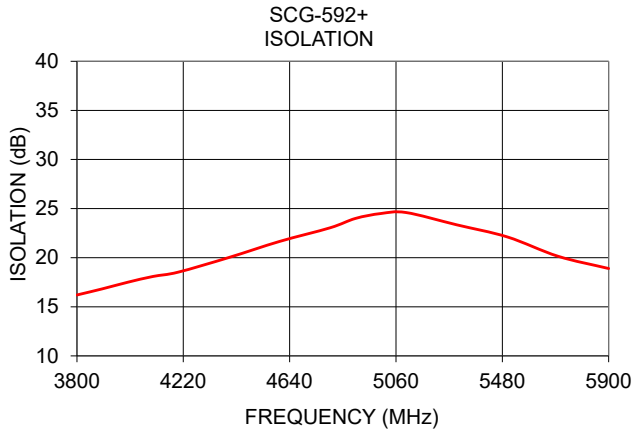
2 Way-0° 50Ω 3800 to 5900 MHz

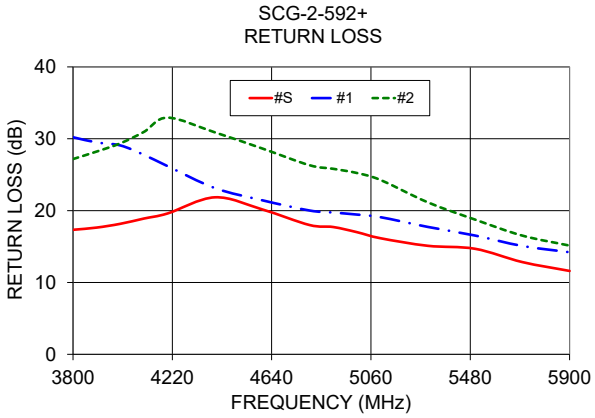
TYPICAL PERFORMANCE DATA

Frequency (MHz)	Total Loss[1] (dB)		Amplitude Unbalance (dB)	Isolation (dB)	Phase Unbalance (deg.)	Return Loss (dB)		
	S-1	S-2				S	1	2
3800	3.46	3.49	0.03	16.20	0.90	17.33	30.21	27.18
3900	3.48	3.50	0.02	16.83	0.92	17.64	29.49	28.22
4000	3.49	3.50	0.01	17.50	0.99	18.16	29.07	29.36
4100	3.50	3.51	0.01	18.09	1.12	18.90	27.76	30.96
4200	3.51	3.52	0.01	18.53	1.15	19.60	26.19	32.94
4400	3.51	3.51	0.00	20.02	1.23	21.85	23.13	30.89
4600	3.53	3.51	0.02	21.65	1.32	20.17	21.44	28.65
4800	3.56	3.53	0.03	23.05	1.39	18.00	20.01	26.32
4900	3.56	3.53	0.03	24.00	1.39	17.72	19.74	25.82
5000	3.58	3.55	0.04	24.50	1.40	17.01	19.45	25.24
5100	3.60	3.57	0.03	24.60	1.58	16.16	19.09	24.27
5300	3.66	3.64	0.02	23.35	1.77	15.10	17.73	21.16
5500	3.74	3.72	0.01	22.11	2.01	14.69	16.53	18.75
5700	3.86	3.85	0.01	20.15	1.97	12.84	15.08	16.52
5900	3.98	3.98	0.00	18.90	2.02	11.60	14.21	15.13

1. Total Loss = Insertion Loss + 3dB splitter loss.







NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

2 Way-0° Power Splitter/Combiner SCG-2-592+

Typical Performance Data

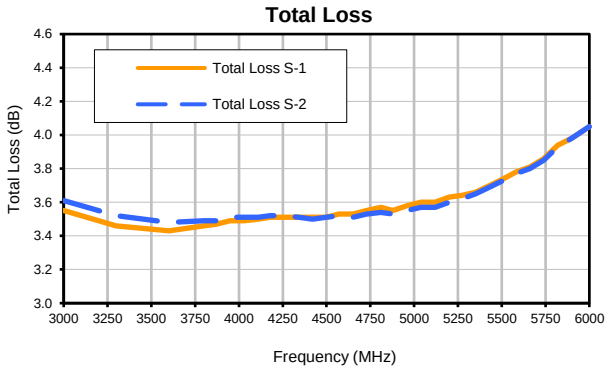
FREQUENCY (MHz)	TOTAL LOSS[1] (dB)		AMPLITUDE UNBALANCE (dB)	ISOLATION (dB)	PHASE UNBALANCE (deg.)
	S-1	S-2		1-2	
3000	3.55	3.61	0.06	11.29	0.69
3300	3.46	3.52	0.05	12.74	0.64
3600	3.43	3.48	0.04	14.74	0.67
3800	3.46	3.49	0.03	16.20	0.71
3870	3.47	3.49	0.02	16.68	0.72
3950	3.49	3.51	0.02	17.03	0.75
4030	3.49	3.51	0.01	17.64	0.76
4110	3.50	3.51	0.01	18.16	0.77
4180	3.51	3.52	0.01	18.41	0.80
4260	3.51	3.52	0.01	19.07	0.88
4340	3.51	3.51	0.00	19.59	0.92
4420	3.51	3.50	0.01	20.05	0.95
4500	3.51	3.51	0.01	20.79	1.03
4570	3.53	3.52	0.01	21.23	1.07
4650	3.53	3.51	0.02	22.09	1.15
4730	3.55	3.53	0.03	22.80	1.20
4810	3.57	3.54	0.03	23.11	1.24
4880	3.55	3.53	0.03	24.08	1.28
4960	3.58	3.55	0.03	24.26	1.33
5040	3.60	3.57	0.03	24.24	1.40
5120	3.60	3.57	0.03	24.65	1.46
5200	3.63	3.60	0.03	23.99	1.51
5270	3.64	3.62	0.02	23.70	1.57
5350	3.66	3.65	0.02	23.42	1.67
5430	3.70	3.69	0.02	22.39	1.77
5510	3.74	3.73	0.01	21.96	1.86
5580	3.78	3.77	0.01	21.25	1.93
5660	3.81	3.80	0.01	20.54	2.01
5740	3.86	3.85	0.01	20.01	2.07
5820	3.94	3.93	0.01	19.21	2.10
5900	3.98	3.98	0.00	18.90	2.11
6000	4.05	4.05	0.01	18.45	2.16

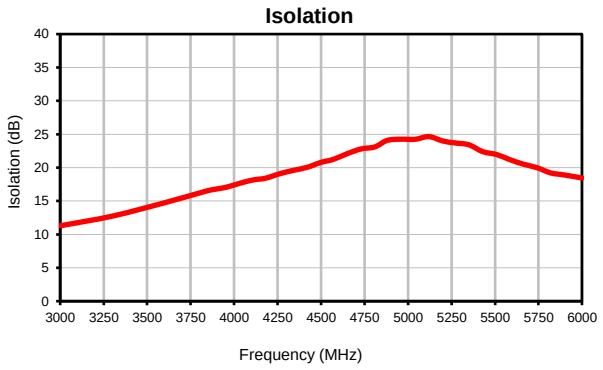
FREQUENCY (MHz)	VSWR (:1)		
	S	1	2
3000	1.58	1.07	1.13
3300	1.45	1.04	1.10
3600	1.34	1.05	1.10
3800	1.31	1.06	1.09
3870	1.30	1.07	1.09
3950	1.31	1.07	1.07
4030	1.27	1.08	1.07
4110	1.25	1.09	1.06
4180	1.24	1.10	1.05
4260	1.20	1.12	1.05
4340	1.19	1.13	1.05
4420	1.19	1.16	1.06
4500	1.19	1.17	1.07
4570	1.22	1.18	1.07
4650	1.23	1.20	1.09
4730	1.26	1.21	1.09
4810	1.29	1.22	1.10
4880	1.29	1.22	1.10
4960	1.33	1.24	1.11
5040	1.36	1.25	1.13
5120	1.36	1.25	1.13
5200	1.41	1.27	1.16
5270	1.40	1.29	1.18
5350	1.42	1.30	1.20
5430	1.45	1.33	1.24
5510	1.45	1.36	1.27
5580	1.51	1.38	1.30
5660	1.53	1.41	1.33
5740	1.60	1.43	1.36
5820	1.71	1.47	1.41
5900	1.71	1.48	1.42
6000	1.81	1.51	1.47

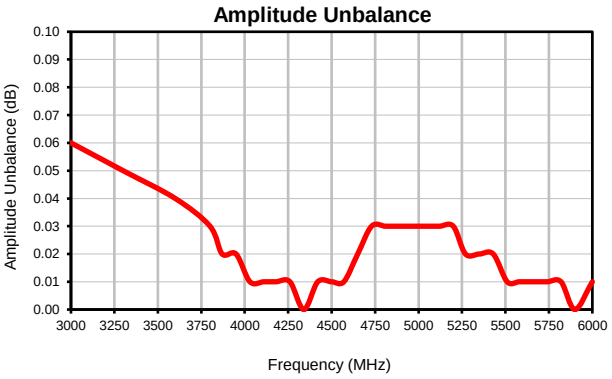
[1]Total Loss = Insertion Loss + 3dB Splitter Loss

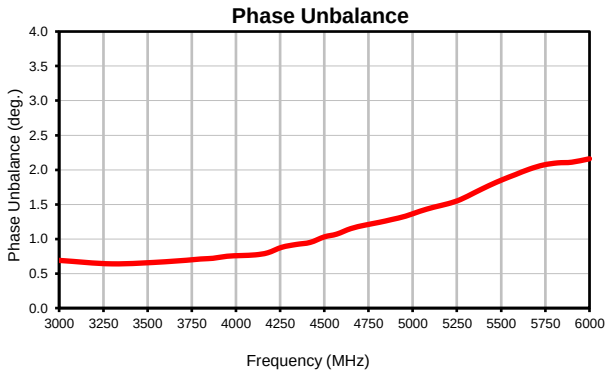
2 Way-0° Power Splitter/Combiner SCG-2-592+

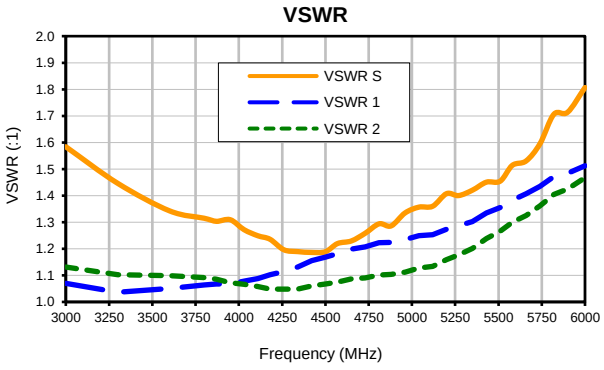
Typical Performance Curves





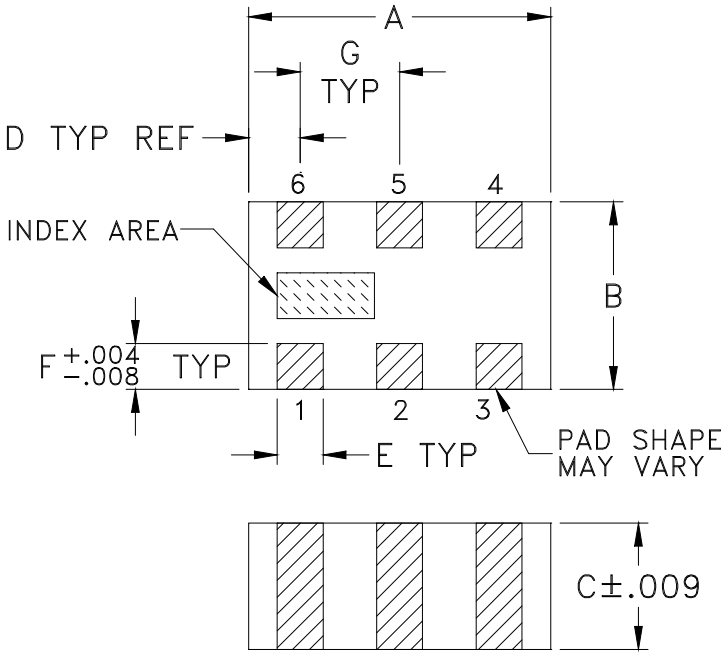




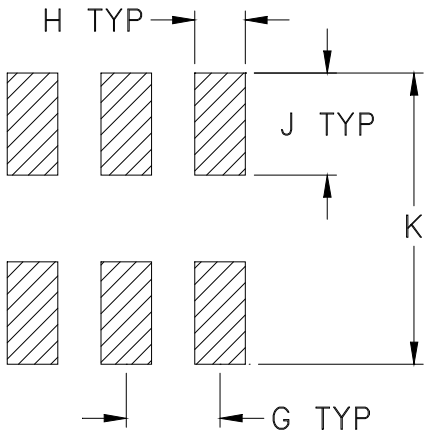


GE0805C-1

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
GE0805C-1	.079 (2.00)	.049 (1.25)	.033 (0.84)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Style: Tin-lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F74

DEVICE ORIENTATION IN T&R

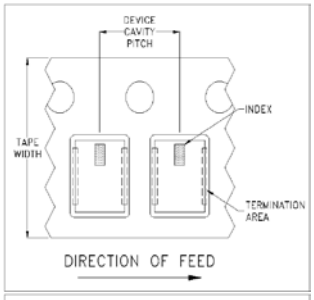


ILLUSTRATION 1

Applicable Case Styles
GE0805C-1
GE0805C-1AP
JV1210C-1
GU2939

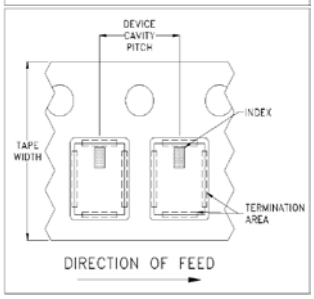


ILLUSTRATION 2

Applicable Case Styles
JV1210C
JV1210C-2
JV1210C-3
JV1210C-4
JV1210C-5
JV1210C-6
JV1210C-11

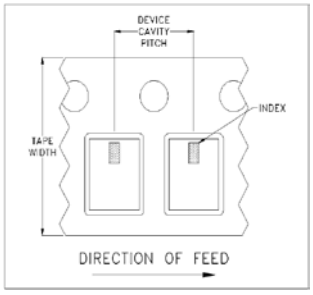


ILLUSTRATION 3

Applicable Case Styles
JC0603C-8
JV1210C-7
JV1210C-8
JV1210C-9
JV1210C-10
JV1210C-13
GE0805C-13

Tape Width, mm	Device Cavity Pitch, mm	Real Size, inches	Devices per Reel	
8	4	7	Small quantity standards **(see note)**	20
				50
				100
				200
				500
				1000
			Standard	2000
				4000

Note: Small reel availability varies by model. Refer to pricing and availability on individual model dashboard.

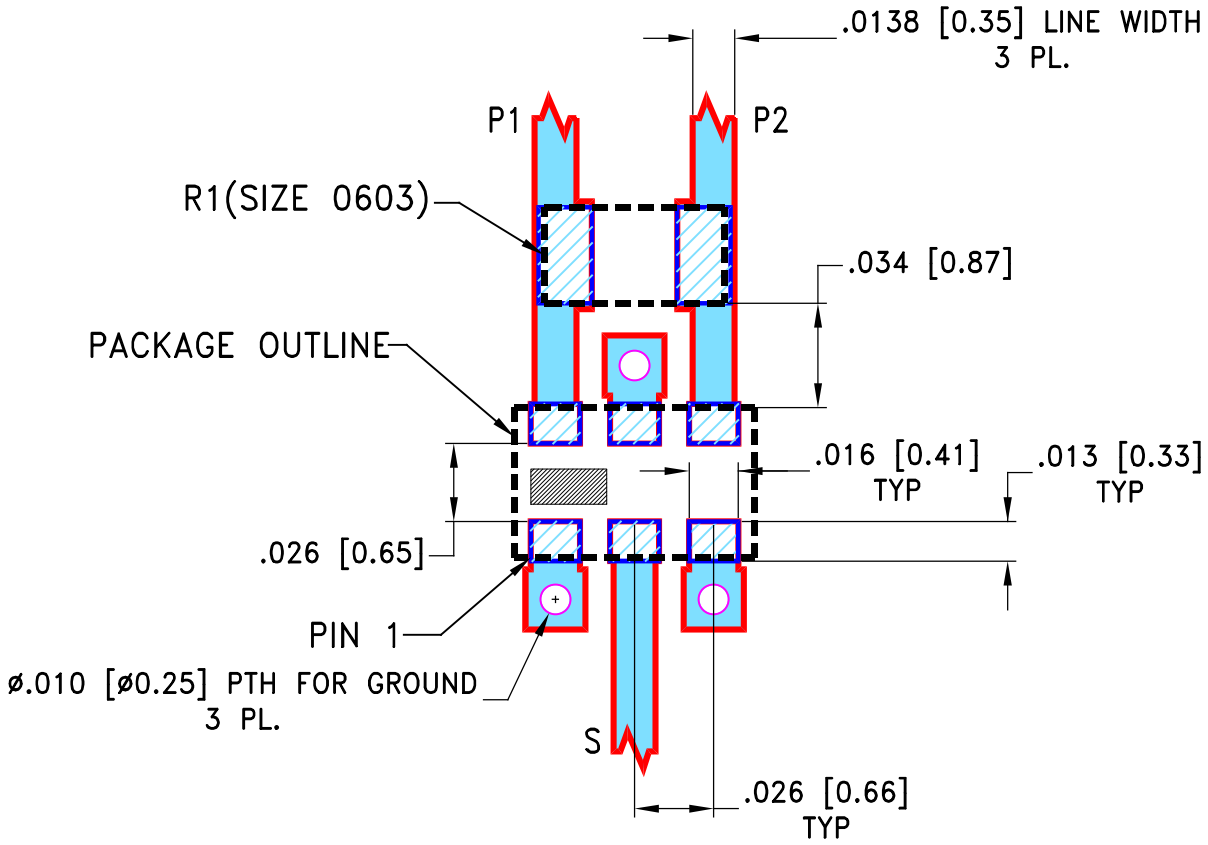
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.
Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits®
INTERNET http://www.minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661
Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010
Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M172101	NEW RELEASE	02/20/19	ITG	SL
A	ECO-004368	ADDED DIMENSIONS IN [MM]		GF	

SUGGESTED MOUNTING CONFIGURATION
FOR GE0805C-1 CASE STYLE, "06SP17" PIN CODE



NOTES:

1. LINE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066±.0007 [.168±.018]. COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS LINE WIDTH MAY NEED TO BE MODIFIED.
2. UNIT FOOT PRINT IS OPTIMIZED FOR PERFORMANCE AND IS DIFFERENT FROM CASE STYLE GE0805C-1 RECOMMENDATIONS.
3. CHIP COMPONENT FOOT PRINT IS SHOWN FOR REFERENCE. FOR COMPONENT VALUE REFER TO TB-1043+.
4. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES[MM]	DRAWN	ITG	01/21/19
TOLERANCES ON:	CHECKED	GF	01/22/19
2 PL DECIMALS ±	APPROVED	SL	02/20/19
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

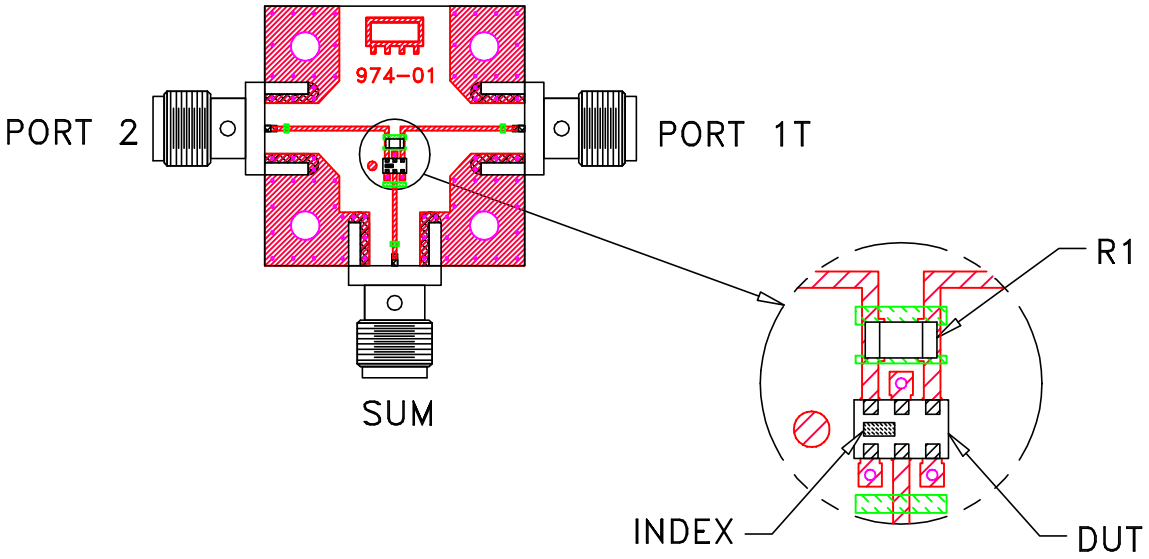
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 06SP17, GE0805C-1, TB-1043+

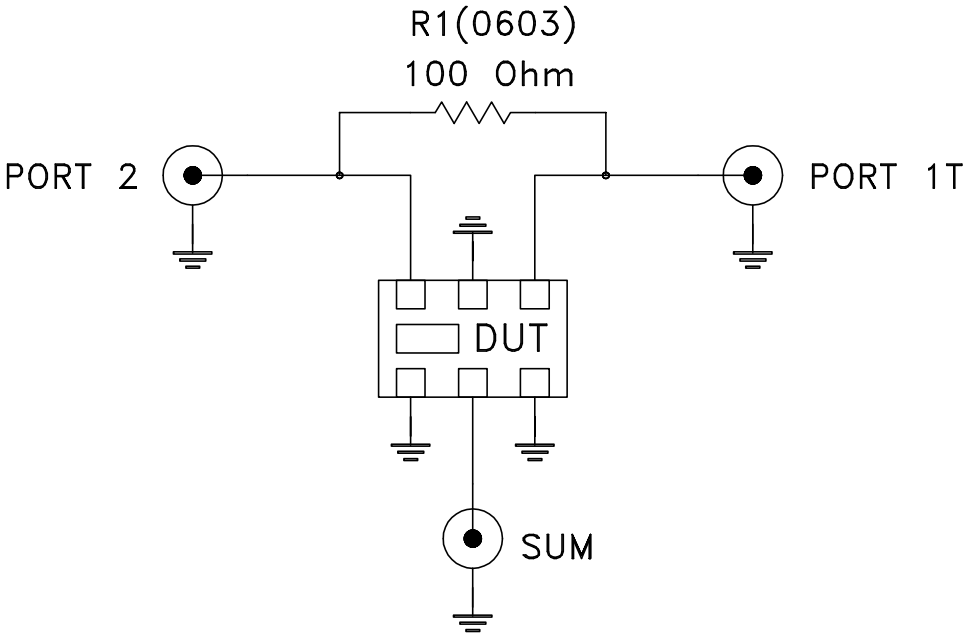
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-560	A

FILE:	SCALE:	SHEET:
98PL560	15:1	1 OF 1

Evaluation Board and Circuit



TB-1043+



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.0066 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A